

## Single Step-up DC/DC Controller

### Features

- **2.5 to 5.5V Input Voltage Range**
- **Adjustable Frequency: Maximum 1MHZ**
- **Incorporates Soft-Start Function**
- **Built-in Short-Circuit Detection Circuit (SCP)**
- **Low Operating Current: Maximum to 1mA**
- **Low Shutdown Current: Maximum to 1mA**
- **Package: SOP-8, MSOP-8, TDFN2x2-8 and TSSOP-8**
- **Under-Voltage Lockout**
- **Lead Free and Green Devices Available (RoHS Compliant)**

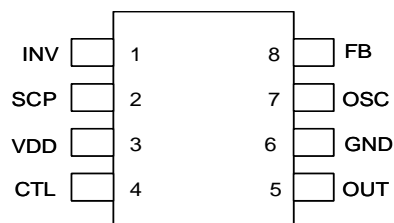
### Applications

- **LCD Display Power Source**
- **Camcorders VCRs, MP3, and Digital Still Camera**
- **Hand-held and Communication Instruments**
- **PDA's**

### General Description

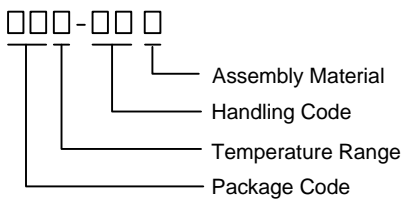
The APW7078 is a single PWM, step-up DC-DC controller with low operating voltage application integrating soft-start and short circuit detection function. The oscillator switching frequency on chip can be operated by terminating OSC pin to connect capacitor and resistor for adjustable operating frequency. Soft-start is adjusted with the external capacitor, which sets the input current ramp. Besides, the external compensation FB pin will apply the flexibility in the dynamic loop status, which allows using small and low equivalent series resistance (ESR) ceramic output capacitors.

### Pin Configuration



ANPEC reserves the right to make changes to improve reliability or manufacturability without notice, and advise customers to obtain the latest version of relevant information to verify before placing orders.

## Ordering and Marking Information

APW7078    □□□-□□□ 	Package Code K : SOP-8   X : MSOP-8   O : TSSOP-8   QB : TDFN2x2-8 Temperature Range I : -40 to 85 C Handling Code TR : Tape & Reel Assembly Material L : Lead Free Device G : Halogen and Lead Free Device			
APW7078 K : <table border="1" style="display: inline-table;"><tr><td>APW7078</td></tr><tr><td>XXXXX</td></tr></table>	APW7078	XXXXX	XXXXXX - Date Code	
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Note: ANPEC lead-free products contain molding compounds/die attach materials and 100% matte tin plate termination finish; which are fully compliant with RoHS. ANPEC lead-free products meet or exceed the lead-free requirements of IPC/JEDEC J-STD-020D for MSL classification at lead-free peak reflow temperature. ANPEC defines "Green" to mean lead-free (RoHS compliant) and halogen free (Br or Cl does not exceed 900ppm by weight in homogeneous material and total of Br and Cl does not exceed 1500ppm by weight).

## Absolute Maximum Ratings

Symbol	Parameter	Rating	Unit
V <sub>DD</sub>	Supply Voltage	-0.3 to 7	V
V <sub>IO</sub>	Input / Output Pins	-0.3 to 7	V
T <sub>A</sub>	Operating Ambient Temperature Range	-40 to 85	°C
T <sub>J</sub>	Junction Temperature Range	-40 to 150	°C
T <sub>STG</sub>	Storage Temperature Range	-65 to +150	°C
T <sub>SDR</sub>	Maximum Lead Soldering Temperature, 10 Seconds	260	°C

Note1: Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability

## Recommended Operating Conditions

Symbol	Parameter	Rating			Unit
		Min.	Typ.	Max.	
V <sub>DD</sub>	Supply Voltage	2.5	-	5.5	V
V <sub>INV</sub>	Error Amplifier Invert Input Voltage	-0.2	-	1	V

## Recommended Operating Conditions (Cont.)

Symbol	Parameter	Rating			Unit
		Min.	Typ.	Max.	
V <sub>CTL</sub>	Control Pin Input Voltage	-0.2	-	V <sub>DD</sub>	V
C <sub>SCP</sub>	SCP Pin Capacitor	-	0.1	-	μF
R <sub>T</sub>	Timing Resistance	1.0	3.3	10	kΩ
C <sub>T</sub>	Timing Capacitor	100	-	270	pF
F <sub>SW</sub>	Oscillator Frequency	200	600	1000	kHz

## Electrical Characteristics

(T<sub>A</sub> = 25°C, V<sub>DD</sub> = 3.3V, unless otherwise specified)

Symbol	Parameter	Test Conditions	APW7078			Unit
			Min.	Typ.	Max.	
<b>ENTIRE DEVICE</b>						
V <sub>DD</sub>	Supply Voltage		2.5	-	5.5	V
I <sub>DD</sub>	Supply Current	V <sub>DD</sub> =2.5V to 5.5V	-	0.7	1	mA
I <sub>SD</sub>	Shutdown Current	CTL pin open or VDD	-	0.1	1	μA
D <sub>MAX</sub>	Maximum Duty Cycle	R <sub>T</sub> =3.3kΩ, C <sub>T</sub> =270pF	80	85	92	%
<b>UNDER-VOLTAGE LOCKOUT PROTECTION</b>						
V <sub>TH</sub>	VDD Startup Threshold Voltage	-	2.0	-	2.4	V
V <sub>R</sub>	Hysteresis voltage	-	-	150	-	mV
<b>SOFT-START</b>						
V <sub>SS</sub>	Voltage at Soft-Start Completion	-	0.7	0.8	0.9	V
I <sub>CS</sub>	Soft-Start Charge Current	V <sub>SCP</sub> =0V	-0.7	-1.0	-1.5	μA
V <sub>SS</sub>	Voltage at Soft-Start Completion	-	0.7	0.8	0.9	V
I <sub>CS</sub>	Soft-Start Charge Current	V <sub>SCP</sub> =0V	-0.7	-1.0	-1.5	μA
<b>SHORT CIRCUIT PROTECTION (SCP)</b>						
V <sub>SCP</sub>	Threshold Voltage		0.7	0.8	0.9	V
I <sub>SCP</sub>	Charge Current	V <sub>SCP</sub> =0V	-0.7	-1.0	-1.5	μA
<b>SAWTOOTH WAVEFORM OSCILLATOR (OSC)</b>						
F <sub>OSC</sub>	Oscillator Frequency	R <sub>T</sub> =3.3kΩ, C <sub>T</sub> =270pF	500	600	700	kHz
F <sub>DV</sub>	Frequency Stability for Voltage	V <sub>DD</sub> =2.5V to 5.5V	-	2	5	%
F <sub>DT</sub>	Frequency Stability for Temperature	T <sub>A</sub> =-40°C to 85°C	-	5	-	%

## Electrical Characteristics (Cont.)

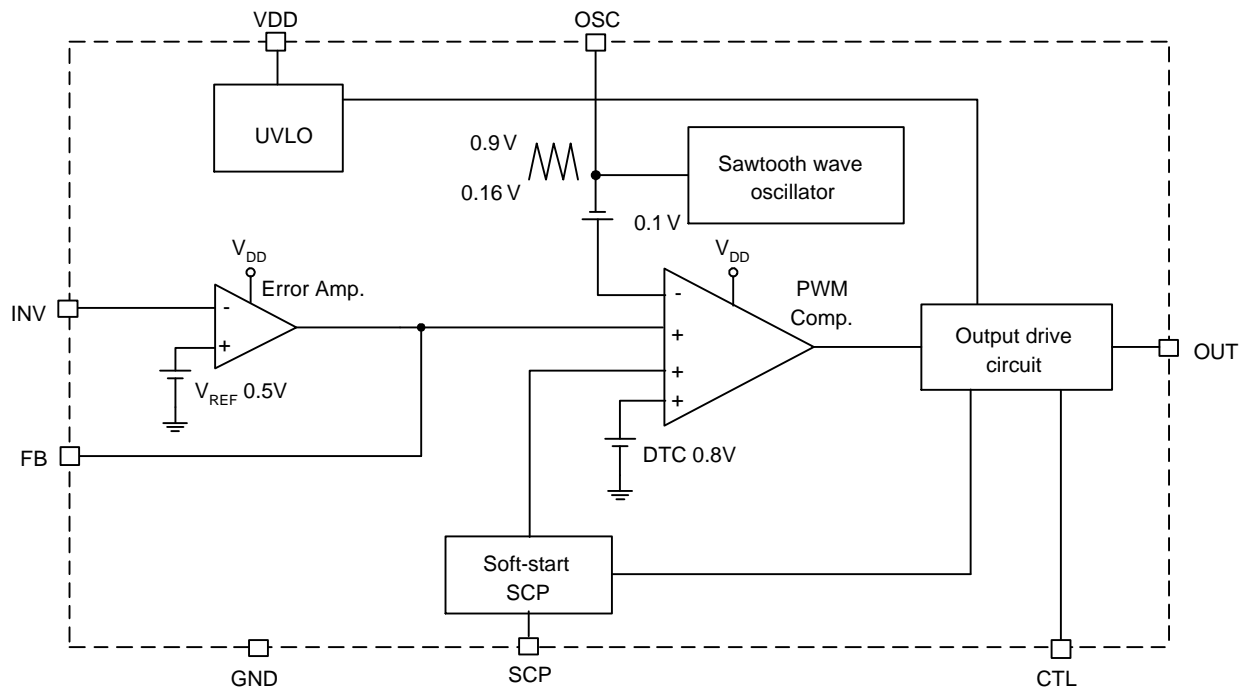
( $T_A = 25^\circ\text{C}$ ,  $V_{DD} = 3.3\text{V}$ , unless otherwise specified)

Symbol	Parameter	Test Conditions	APW7078			Unit
			Min.	Typ.	Max.	
<b>ERROR AMPLIFIER</b>						
$V_{REF}$	Reference Voltage	$V_{FB}=INV$	0.493	0.5	0.508	V
	$V_{REF}$ Stability	$V_{DD}=2.5\text{V to }5.5\text{V}$	-	5	20	mV
	$V_{REF}$ Variation with Temperature	$T_A = -40^\circ\text{C to }85^\circ\text{C}$	-	1	-	%
gm	Transconductance		1000	1300	1600	$\mu\text{A/V}$
$I_B$	Input Bias Current	$INV=0\text{V}$	-	-	1	$\mu\text{A}$
$V_{OH}$	Output Voltage Range	-	1.6	1.8	-	V
$V_{OL}$		-	-	-	0.01	V
	Output Source Current	$INV=0\text{V}, FB=0.5\text{V}$	-150	-180	-210	$\mu\text{A}$
	Output Sink Current	$INV=1\text{V}, FB=0.5\text{V}$	140	170	200	$\mu\text{A}$
<b>PWM CONTROLLER DRIVER</b>						
$I_{SOURCE}$	Output Source Current	Duty<5%, OUT=0V	-150	-200	-	mA
$I_{SINK}$	Output Sink Current	Duty>5%, OUT=5V	150	200	-	mA
<b>CONTROL BLOCK</b>						
$V_{IL}$	Control Voltage	Active mode	-	-	$0.2V_{DD}$	
$V_{IH}$		Switch-off mode	$0.8V_{DD}$	-	-	

### Pin Description

PIN NO.	SYMBOL	I/O	FUNCTION
1	INV	I	Internal 0.5V reference voltage. Use a resistor divider to set the output voltage.
2	SCP	-	Soft-start and short-circuit detection, connects a capacitor from the pin to ground.
3	VDD	-	Power supply input pin for IC voltage.
4	CTL	I	Output control pin. Low = operating mode; High = shutdown mode.
5	OUT	O	External MOSFET driving pin.
6	GND	-	Ground pins of the IC.
7	OSC	-	Setting capacitor and resistor to provide oscillation switching frequency adjustment.
8	FB	O	Error amplifier output pin. Setting circuit for IC compensation.
Exposde Pad	GND	-	Connect this pad to GND (pin6).

### Block Diagram



Application Schematic

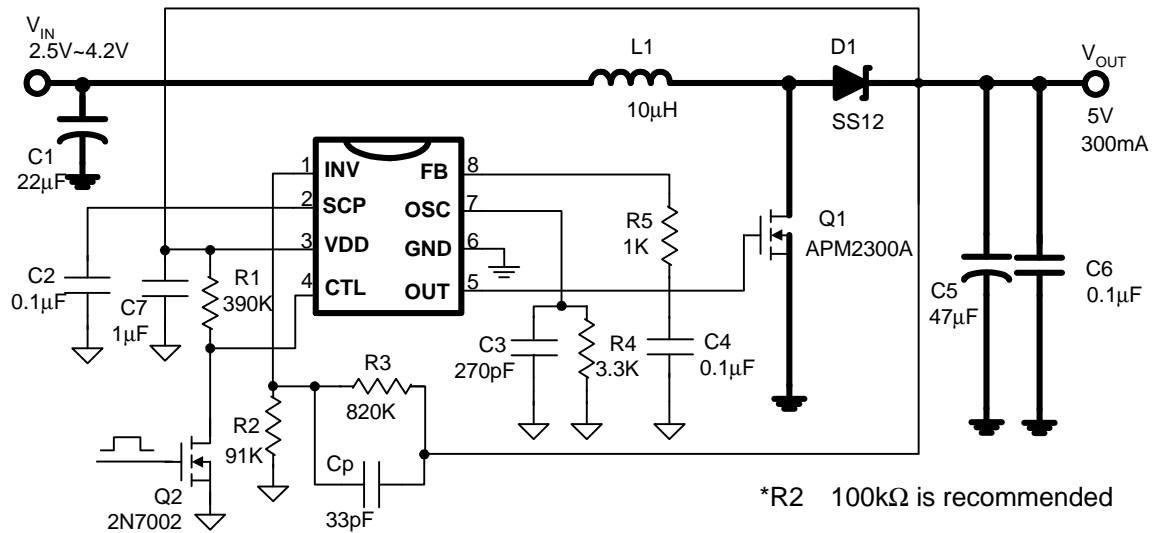


Figure 1: APW7078 Step-up Application for Adjustable Voltage

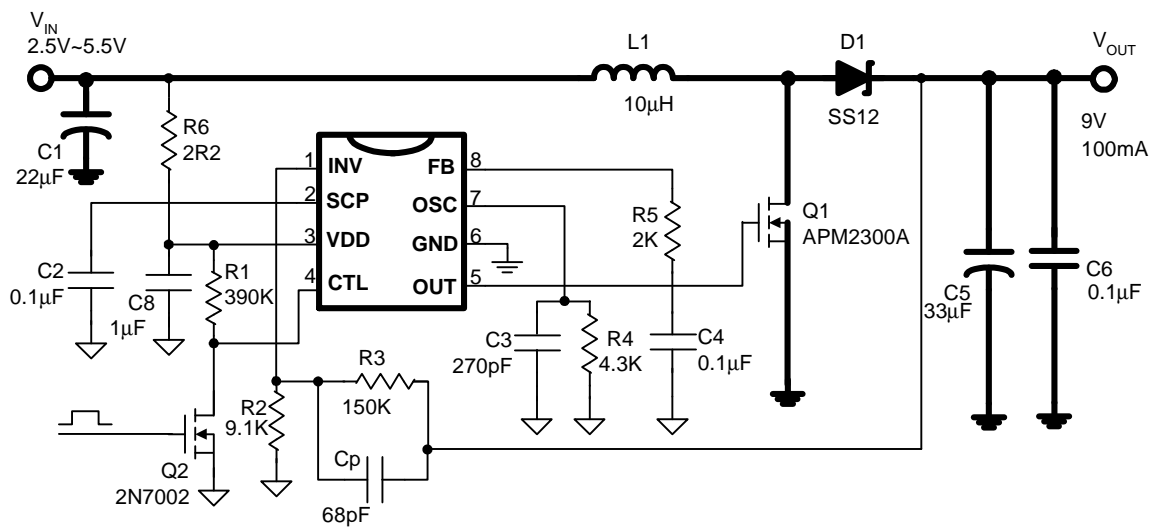


Figure 2: APW7078 Step-up Application for Adjustable Voltage

Application Schematic

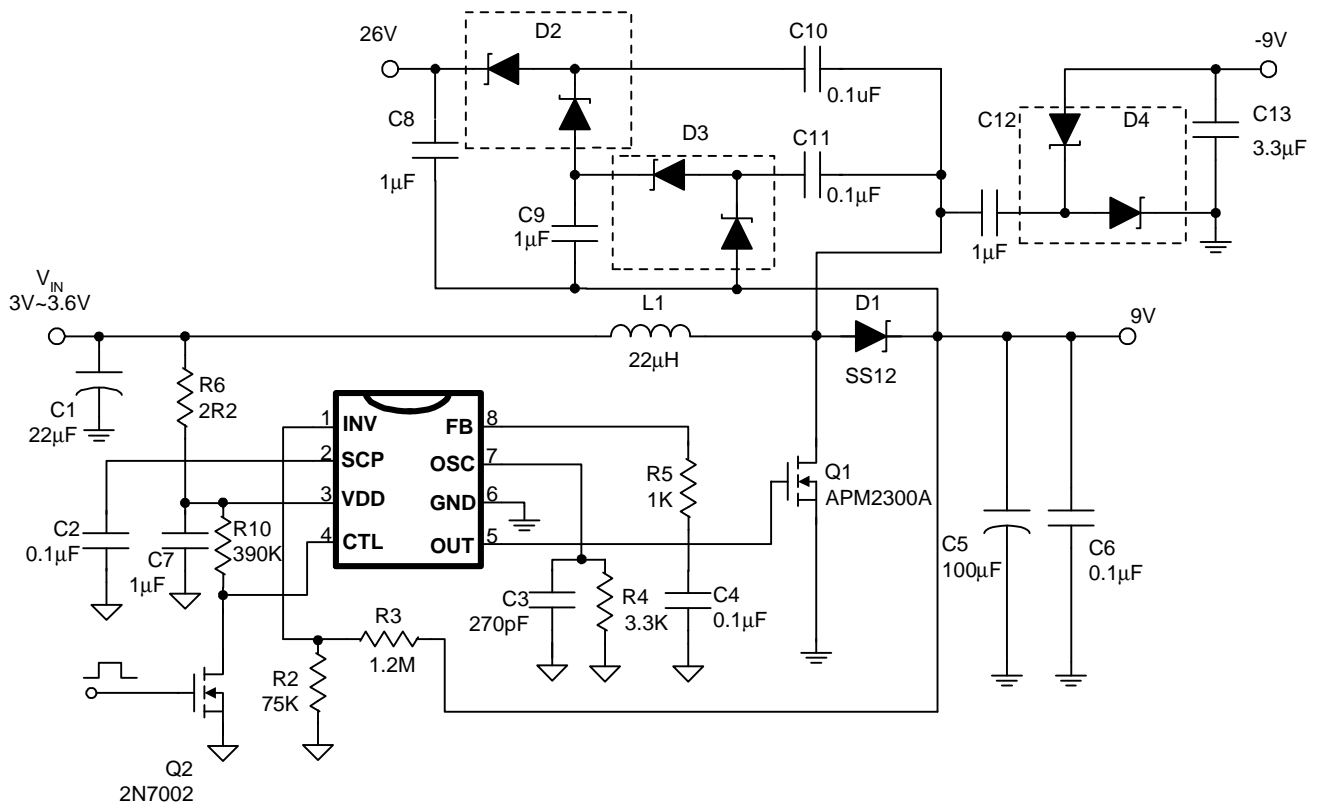
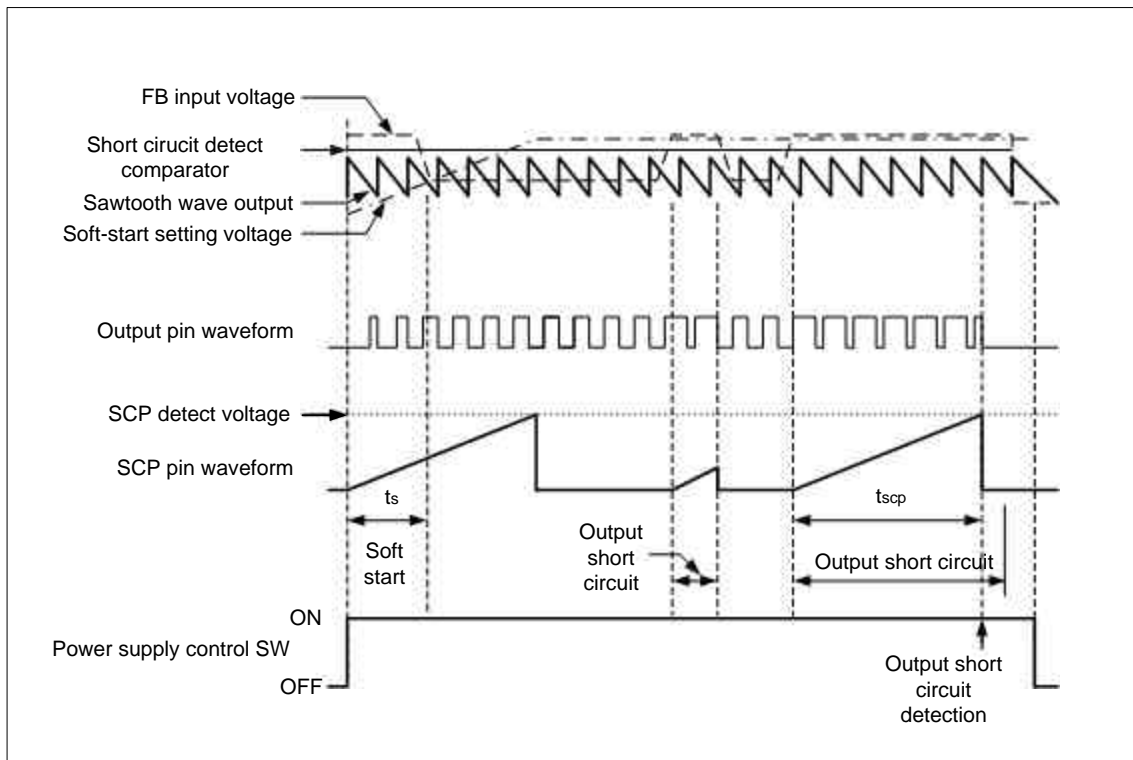


Figure 3. APW7078 Multiple-output for TFT LCD Panel Power

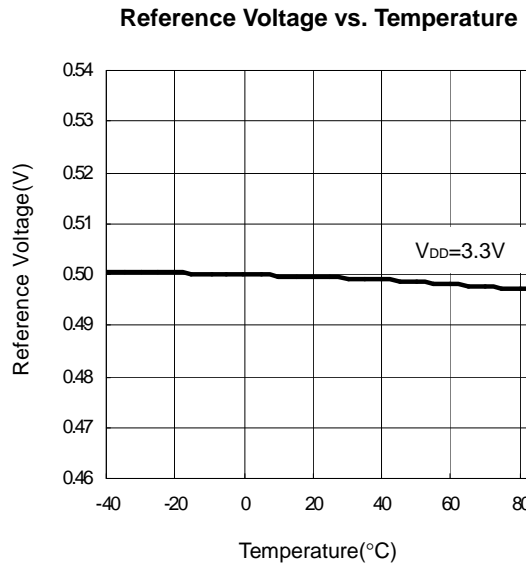
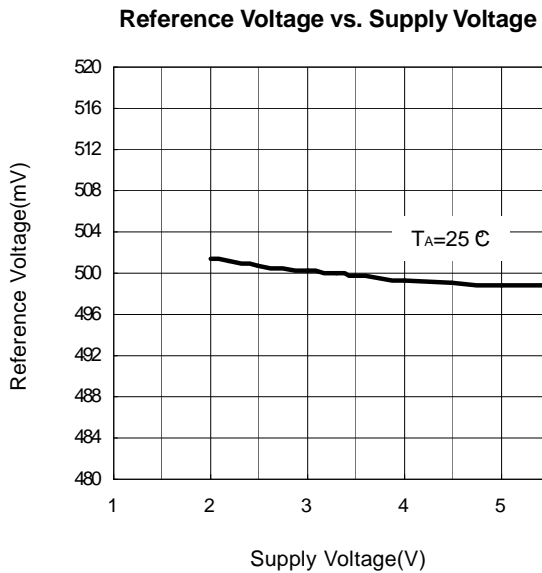
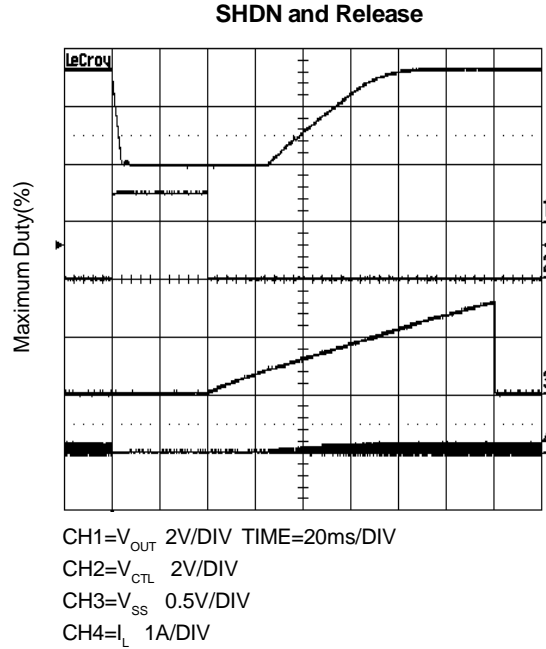
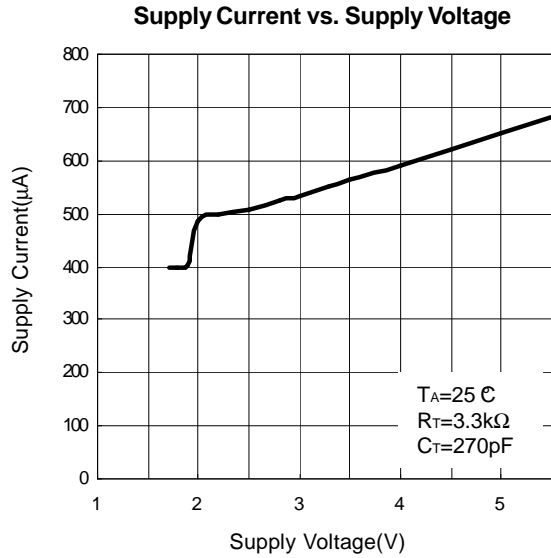
Timing Diagram





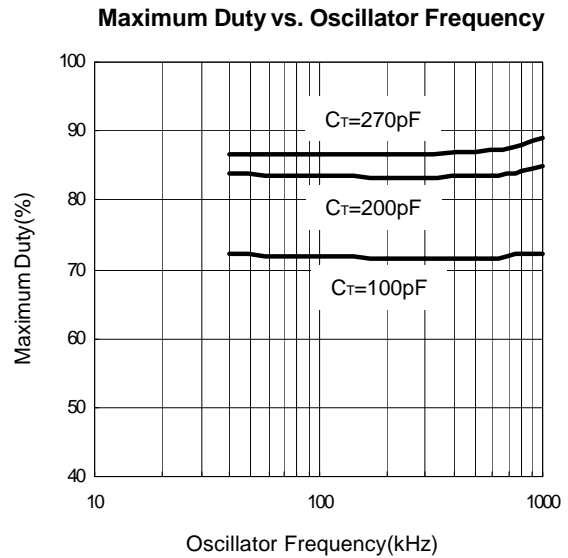
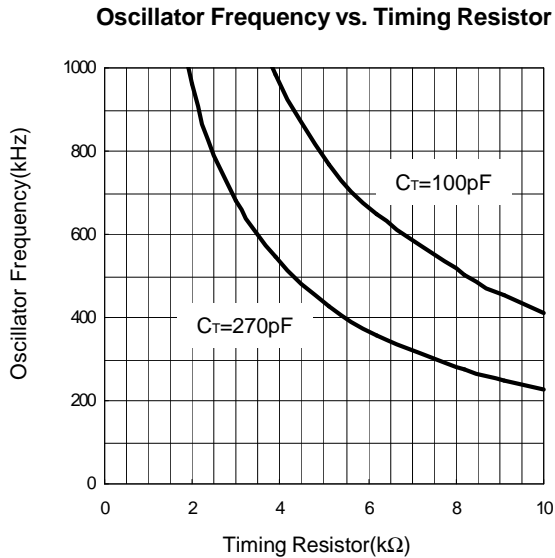
## Typical Operating Characteristics

( $T_A = 25^\circ\text{C}$ ,  $V_{DD} = 3.3\text{V}$ , unless otherwise specified)

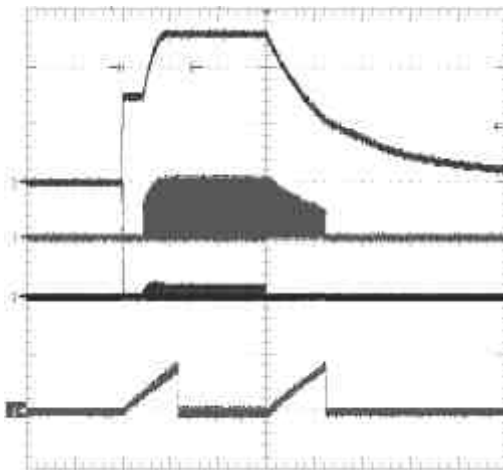


## Typical Operating Characteristics (Cont.)

( $T_A = 25^\circ\text{C}$ ,  $V_{DD} = 3.3\text{V}$ , unless otherwise specified)

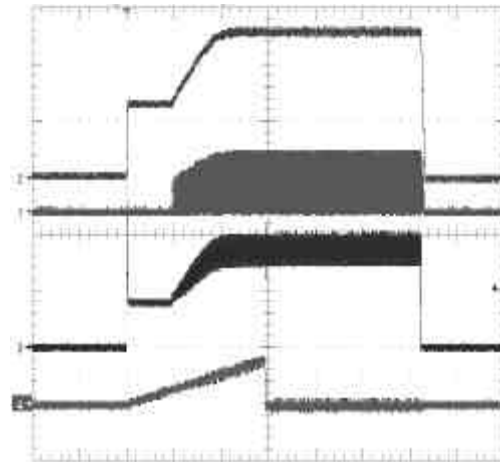


**Power on and off under light load**



$I_{OUT} = 5\text{mA}$ , TIME=40ms/DIV  
 CH1= $V_{OUT}$  5V/DIV  
 CH2= $V_{OUT}=V_{DD}$  2V/DIV  
 CH3= $I_L$  0.5A/DIV  
 CH4= $V_{SS}$  1V/DIV

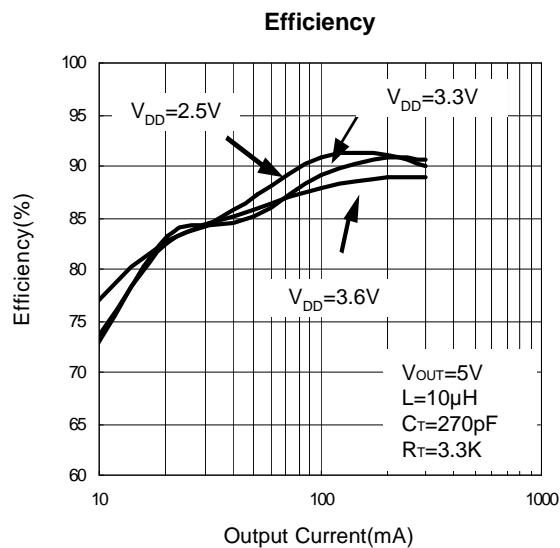
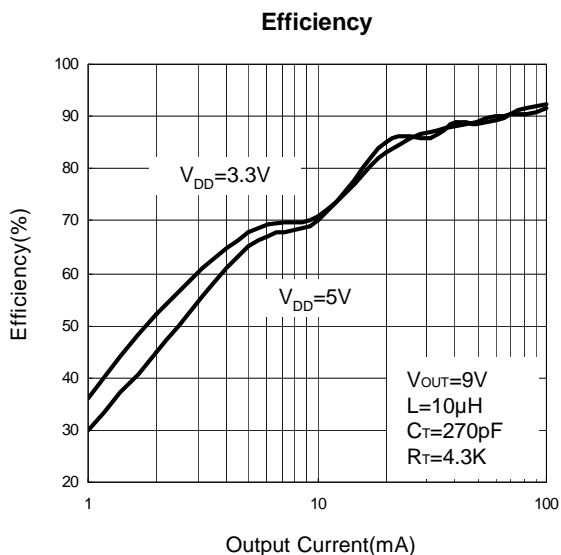
**Power on and off under heavy load**



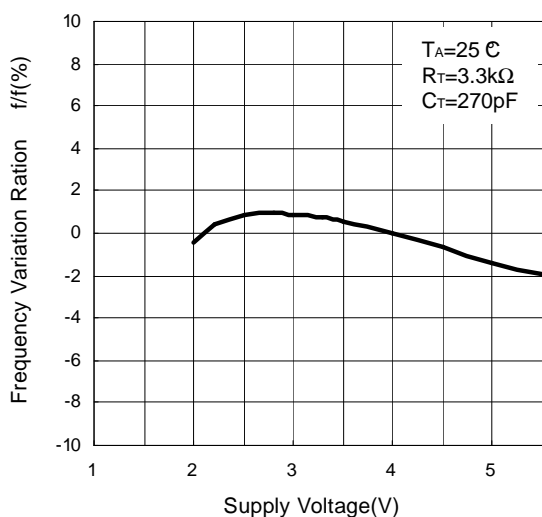
$I_{OUT} = 400\text{mA}$ , TIME=40ms/DIV  
 CH1= $V_{OUT}$  5V/DIV  
 CH2= $V_{OUT}=V_{DD}$  2V/DIV  
 CH3= $I_L$  0.5A/DIV  
 CH4= $V_{SS}$  1V/DIV

## Typical Operating Characteristics (Cont.)

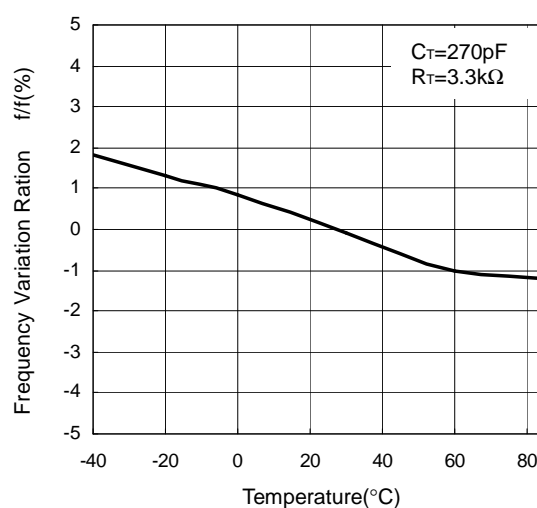
( $T_A = 25^\circ\text{C}$ ,  $V_{DD} = 3.3\text{V}$ , unless otherwise specified)



**Frequency Variation Ratio vs. Supply Voltage**



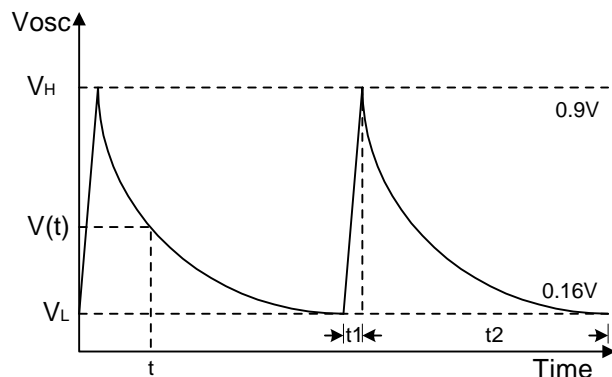
**Frequency Variation Ratio vs. Temperature**



## Function Description

### Setting Oscillating Frequency

The oscillator circuit generates a triangular sawtooth wave with a peak of 0.9V and trough of 0.16V using the timing capacitor ( $C_T$ ) and the timing resistor ( $R_T$ ) that are connected to OSC pin. This oscillator can provide oscillating frequency up to 1MHz.



$$i = C \frac{\Delta V}{\Delta t}$$

$$t_1 = C_T \cdot \frac{0.9V - 0.16V}{2mA} = 370 \cdot C_T$$

$$V(t) = V_H \cdot e^{-\frac{t}{R_T C_T}}$$

$$t_2 = R_T C_T \ln(V_H / V_L) = 1.72 \cdot R_T C_T$$

$$T = t_1 + t_2 = C_T (370 + 1.72 R_T)$$

### Setting Output Voltage

The output voltage is set using the INV pin and a resistor divider connected to the output is shown in the Typical Operating Circuit. The internal reference voltage is 0.5V with 2% variation, so the ratio of the feedback resistors sets the output voltage according to the following equation:

$$V_{OUT} = \left(1 + \frac{R3}{R2}\right) \times 0.5V$$

To avoid the thermal noise from feedback resistor, the resistance R2 is smaller than 100k $\Omega$  and 1% variation is recommended.

### Error Amplifier

The error amplifier detects the output voltage of the switching regulator and outputs the PWM control signal. The

voltage gain is fixed, and connecting a phase compensation resistor and capacitor to the FB pin (pin 8) provides stable phase compensation for the system.

### PWM Comparator

The voltage comparator has one inverting and three non-inverting inputs. The comparator is a voltage/pulse width converter that controls the ON time of the output pulse depending on the input voltage. The output level is high (H) when the sawtooth wave is lower than the error amplifier output voltage, soft-start setting voltage, and idle period setting voltage.

### Output Circuit

The output circuit is a typical push-pull configuration to drive an external NMOS transistor directly. It can provide a 200mA source/sink to/from OUT (pin 5).

### Soft-Start and Short Circuit Detection

Soft-start operation is set by connecting capacitor  $C_{SCP}$  to the SCP pin (pin 2). Soft-start prevents a current spike on start-up. On completion of the soft-start operation, the SCP pin (pin 2) stays low and enters the short circuit detection wait state. When an output short circuit occurs, the error amplifier output is fixed at 1.8V and capacitor  $C_{SCP}$  starts charging.

After charging to approximately 0.8 V, the output pin (pin 5) is set low and the SCP pin stays low. Once the protection circuit operates, the circuit can be restored by resetting the power supply. Short circuit detection time can be calculate as below:

$$t_{SCP} = 0.8 \times C_{SCP} (\mu F)$$

### Under-Voltage Lock Out (UVLO)

Transients during powering on or instantaneous glitches in the supply voltage can cause system damage or failure. The circuit prevents malfunction at low input voltage detects a low input voltage by comparing the supply voltage with the internal reference voltage. On detection, the circuit fixes the output pin to low. The system recovers when the supply voltage rises back above the threshold voltage of the malfunction prevention circuit.

## Function Description (Cont.)

### Layout Consideration

#### Switching Noise Decoupling Capacitor

A 0.1 $\mu$ F ceramic capacitor should be placed close to the VOUT pin and the GND pin of the chip to filter the switching spikes in the output voltage monitored by the VOUT pin.

#### Feedback Network

In APW7078 application, the feedback networks should be connected directly to a dedicated analog ground plane and this ground plane must connect to the GND pin. If no analog ground plane is available, and then this ground must tie directly to the GND pin. The feedback network, resistors R2 and R3, should be kept close to the FB pin, and away from the inductor.

#### Input Capacitor

The input capacitor C<sub>IN</sub> in VIN must be placed close to the IC. This will reduce copper trace resistance which effects input voltage ripple of the IC. For additional input voltage filtering, a 1 $\mu$ F capacitor can be placed in parallel with C<sub>IN</sub>, close to the VDD pin, to shunt any high frequency noise to the ground.

### Demo Board Circuit Layout

#### Inductor

To minimize copper trace connections that can inject noise into the system, the inductor, switch, and schottky diode should be placed as close as possible to minimize the noise coupling into other circuits.

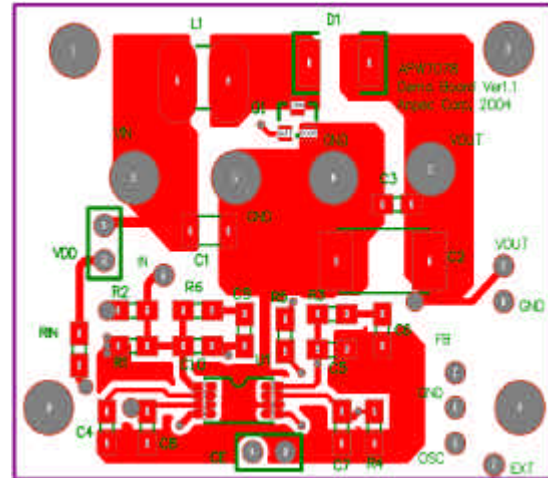
#### Output Capacitor

The output capacitor, C<sub>OUT</sub>, should be placed close to the diode and output terminals to obtain better smoothing effect on the output ripple. Any copper trace connections for the C<sub>OUT</sub> capacitor can increase the series resistance, which directly effects output voltage ripple and efficiency.

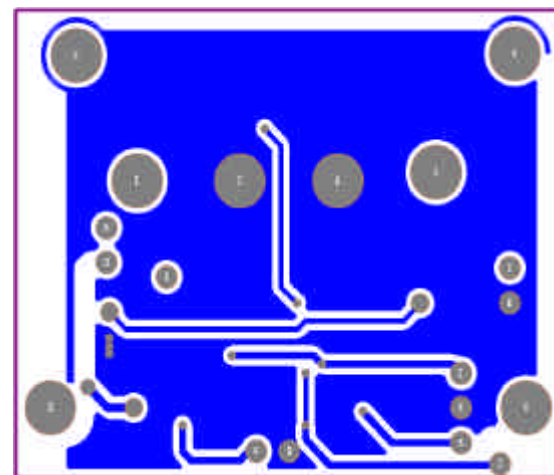
#### Ground Plane

One point grounding should be used for the output power return ground, the input power return to the ground and the device switches the ground to reduce noise. The input ground and output ground traces must be thick enough for current to flow through and for reducing the ground bounce.

Top Layer

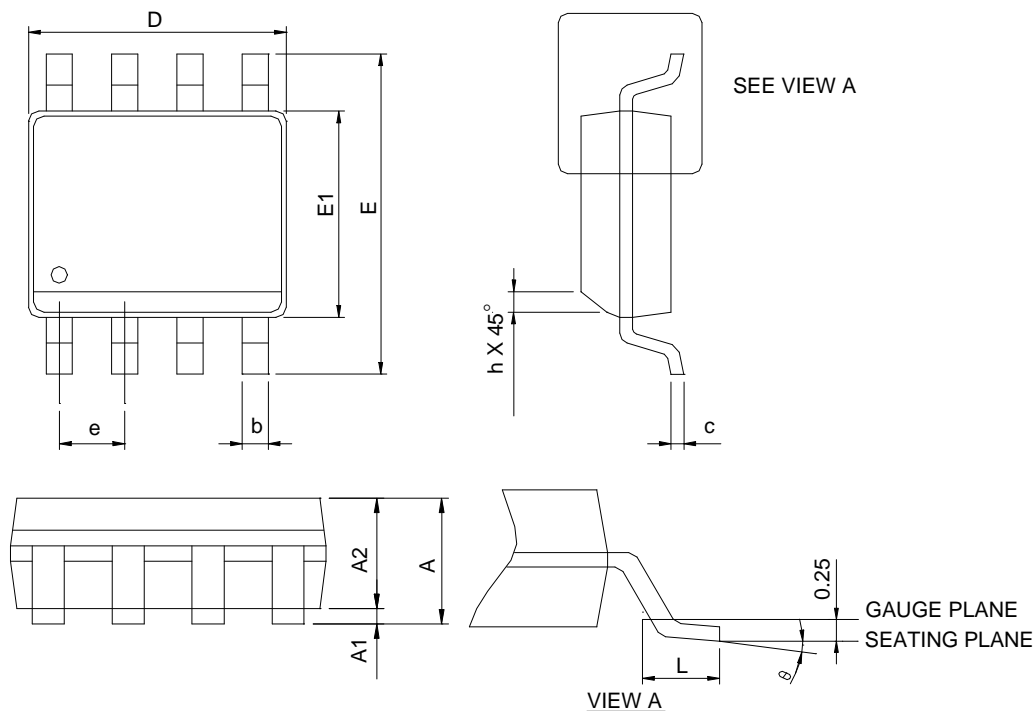


Bottom Layer



Package Information

SOP-8

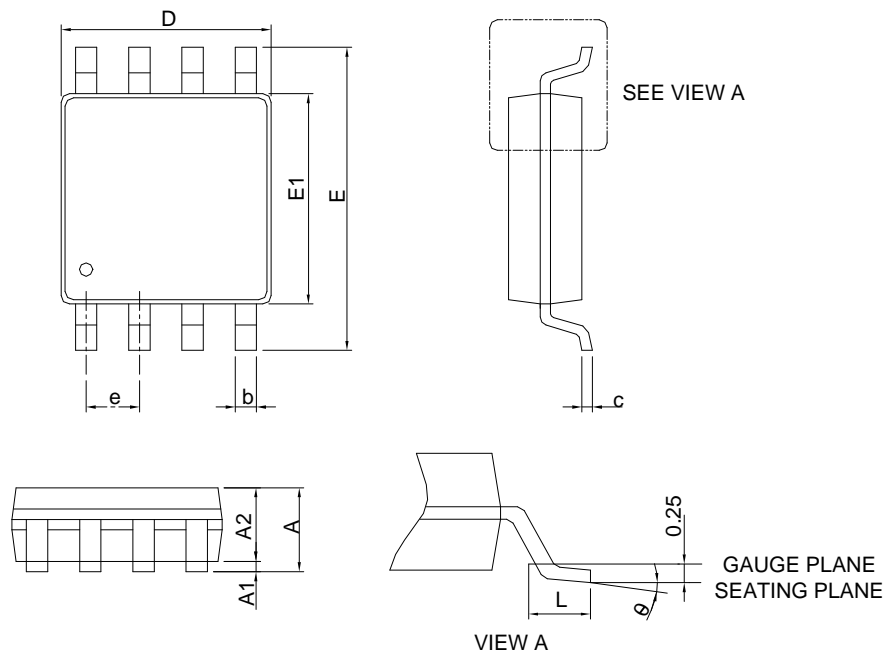


SYMBOL	SOP-8			
	MILLIMETERS		INCHES	
	MIN.	MAX.	MIN.	MAX.
A		1.75		0.069
A1	0.10	0.25	0.004	0.010
A2	1.25		0.049	
b	0.31	0.51	0.012	0.020
c	0.17	0.25	0.007	0.010
D	4.80	5.00	0.189	0.197
E	5.80	6.20	0.228	0.244
E1	3.80	4.00	0.150	0.157
e	1.27 BSC		0.050 BSC	
h	0.25	0.50	0.010	0.020
L	0.40	1.27	0.016	0.050
θ	0°	8°	0°	8°

- Note: 1. Follow JEDEC MS-012 AA.  
 2. Dimension "D" does not include mold flash, protrusions or gate burrs. Mold flash, protrusion or gate burrs shall not exceed 6 mil per side.  
 3. Dimension "E" does not include inter-lead flash or protrusions. Inter-lead flash and protrusions shall not exceed 10 mil per side.

Package Information

MSOP-8

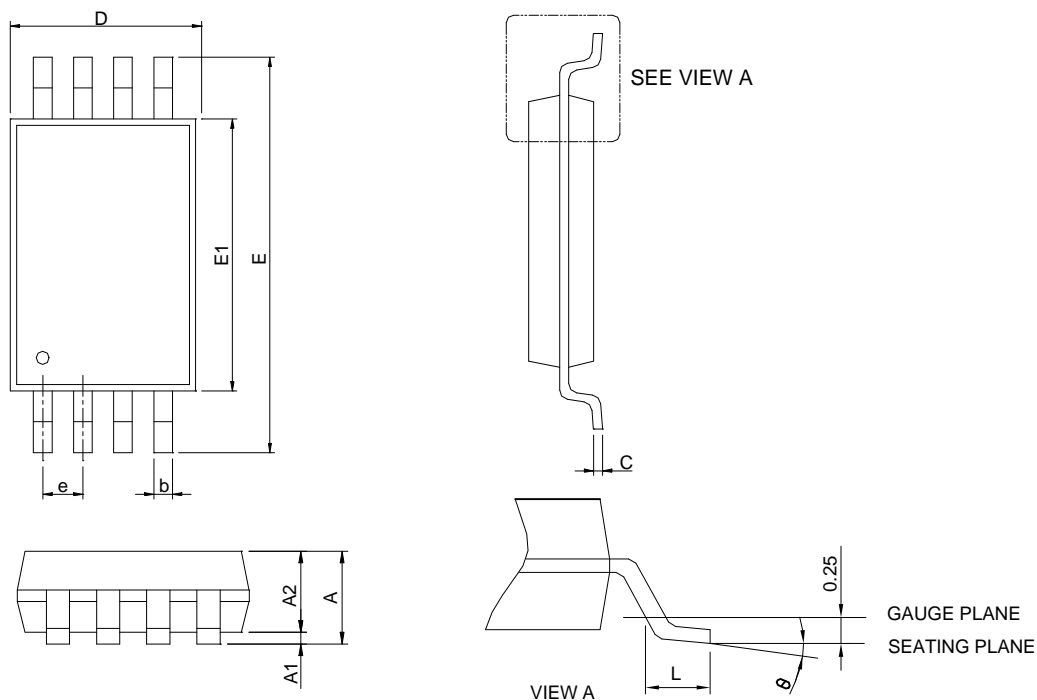


SYMBOL	MSOP-8			
	MILLIMETERS		INCHES	
	MIN.	MAX.	MIN.	MAX.
A		1.10		0.043
A1	0.00	0.15	0.000	0.006
A2	0.75	0.95	0.030	0.037
b	0.22	0.38	0.009	0.015
c	0.08	0.23	0.003	0.009
D	2.90	3.10	0.114	0.122
E	4.70	5.10	0.185	0.201
E1	2.90	3.10	0.114	0.122
e	0.65 BSC		0.026 BSC	
L	0.40	0.80	0.016	0.031
$\theta$	0°	8°	0°	8°

- Note: 1. Follow JEDEC MO-187 AA.  
 2. Dimension " D " does not include mold flash, protrusions or gate burrs. Mold flash, protrusion or gate burrs shall not exceed 6 mil per side.  
 3. Dimension " E1 " does not include inter-lead flash or protrusions. Inter-lead flash and protrusions shall not exceed 5 mil per side.

Package Information

TSSOP-8



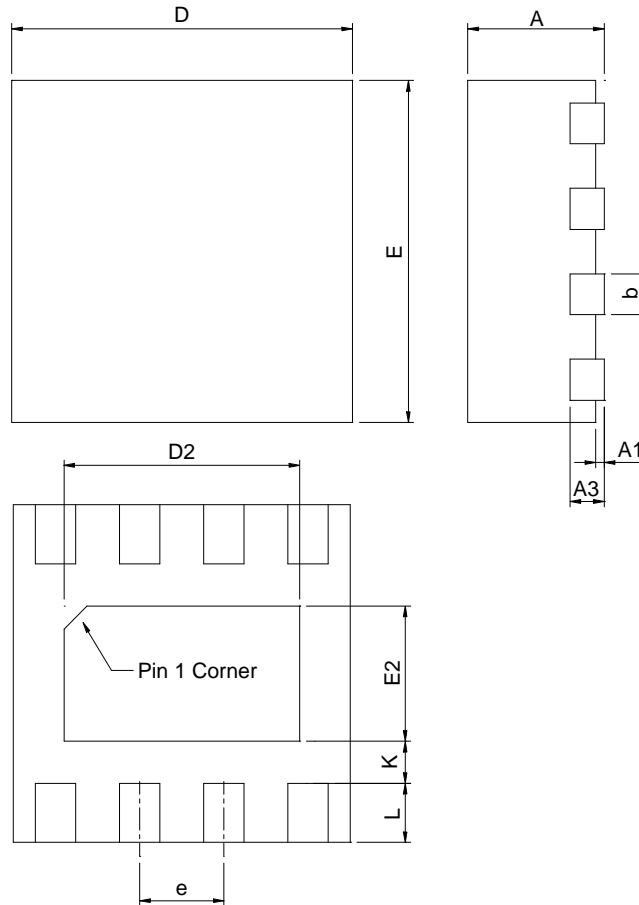
SYMBOL	TSSOP-8			
	MILLIMETERS		INCHES	
	MIN.	MAX.	MIN.	MAX.
A		1.20		0.047
A1	0.05	0.15	0.002	0.006
A2	0.80	1.05	0.031	0.041
b	0.19	0.30	0.007	0.012
c	0.09	0.20	0.004	0.008
D	2.90	3.10	0.114	0.122
E	6.20	6.60	0.244	0.260
E1	4.30	4.50	0.169	0.177
e	0.65 BSC		0.026 BSC	
L	0.45	0.75	0.018	0.030
θ	0°	8°	0°	8°

- Note : 1. Follow JEDEC MO-153 AA  
 2. Dimension "D" does not include mold flash, protrusions or gate burrs. Mold flash, protrusion or gate burrs shall not exceed 6 mil per side.  
 3. Dimension "E1" does not include inter-lead flash or protrusions. Inter-lead flash and protrusions shall not exceed 10 mil per side.



Package Information

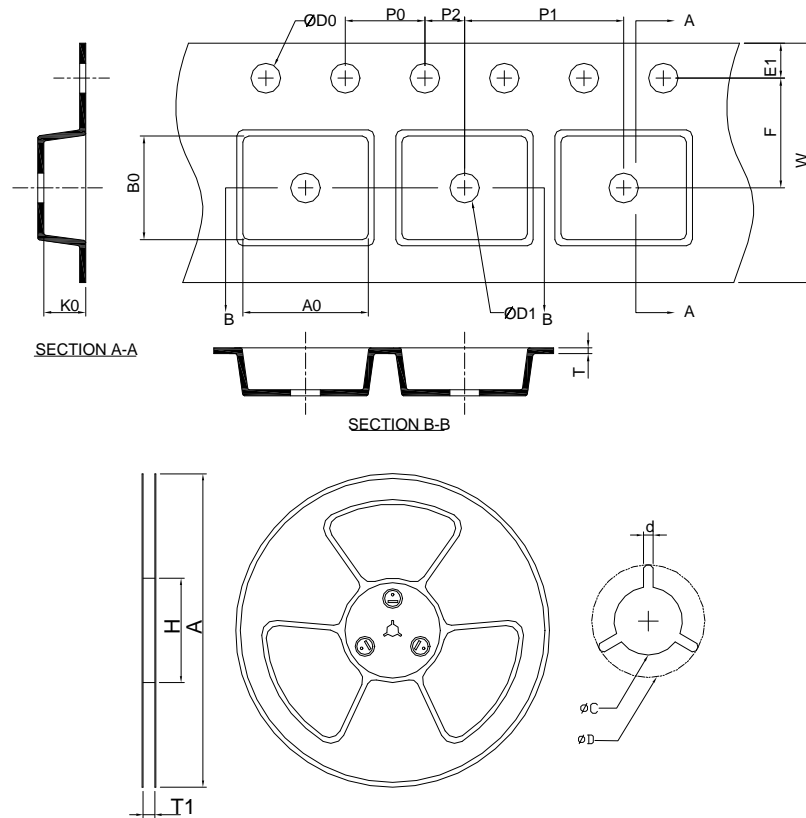
TDFN2x2-8



SYMBOL	TDFN2x2-8			
	MILLIMETERS		INCHES	
	MIN.	MAX.	MIN.	MAX.
A	0.70	0.80	0.028	0.031
A1	0.00	0.05	0.000	0.002
A3	0.20 REF		0.008 REF	
b	0.18	0.30	0.007	0.012
D	1.90	2.10	0.075	0.083
D2	1.00	1.60	0.039	0.063
E	1.90	2.10	0.075	0.083
E2	0.60	1.00	0.024	0.039
e	0.50 BSC		0.020 BSC	
L	0.30	0.45	0.012	0.018
K	0.20		0.008	

Note : 1. Followed from JEDEC MO-229 WCCD-3.

### Carrier Tape & Reel Dimensions



Application	A	H	T1	C	d	D	W	E1	F
SOP-8	330.0 ±2.00	50 MIN.	12.4+2.00 -0.00	13.0+0.50 -0.20	1.5 MIN.	20.2 MIN.	12.0 ±0.30	1.75 ±0.10	5.5 ±0.05
	P0	P1	P2	D0	D1	T	A0	B0	K0
	4.0 ±0.10	8.0 ±0.10	2.0 ±0.05	1.5+0.10 -0.00	1.5 MIN.	0.6+0.00 -0.40	6.40 ±0.20	5.20 ±0.20	2.10 ±0.20
Application	A	H	T1	C	d	D	W	E1	F
MSOP-8	330.0 ±2.00	50 MIN.	12.4+2.00 -0.00	13.0+0.50 -0.20	1.5 MIN.	20.2 MIN.	12.0 ±0.30	1.75 ±0.10	5.5 ±0.05
	P0	P1	P2	D0	D1	T	A0	B0	K0
	4.00 ±0.10	8.00 ±0.10	2.00 ±0.05	1.5+0.10 -0.00	1.5 MIN.	0.6+0.00 -0.40	5.30 ±0.20	3.30 ±0.20	1.40 ±0.20
Application	A	H	T1	C	d	D	W	E1	F
TSSOP-8	330.0 ±2.00	50 MIN.	12.4+2.00 -0.00	13.0+0.50 -0.20	1.5 MIN.	20.2 MIN.	12.0 ±0.30	1.75 ±0.10	5.5 ±0.10
	P0	P1	P2	D0	D1	T	A0	B0	K0
	4.00 ±0.10	8.00 ±0.10	2.00 ±0.05	1.5+0.10 -0.00	1.5 MIN.	0.6+0.00 -0.40	6.90 ±0.20	3.40 ±0.20	1.60 ±0.20
Application	A	H	T1	C	d	D	W	E1	F
TDFN2x2-8	178.0 ±2.00	50 MIN.	8.4+2.00 -0.00	13.0+0.50 -0.20	1.5 MIN.	20.2 MIN.	8.0 ±0.20	1.75 ±0.10	3.50 ±0.05
	P0	P1	P2	D0	D1	T	A0	B0	K0
	4.0 ±0.10	4.0 ±0.10	2.0 ±0.05	1.5+0.10 -0.00	1.5 MIN.	0.6+0.00 -0.4	3.35 MIN	3.35 MIN	1.30 ±0.20

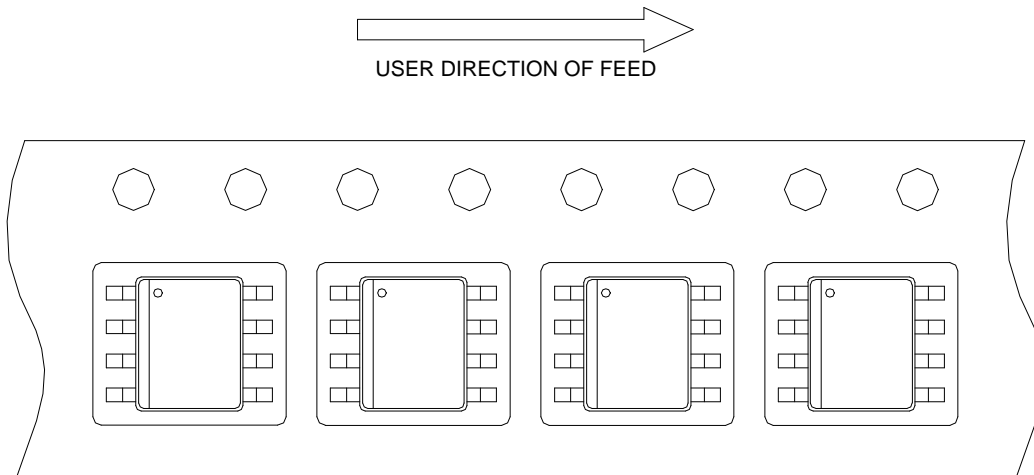
(mm)

**Devices Per Unit**

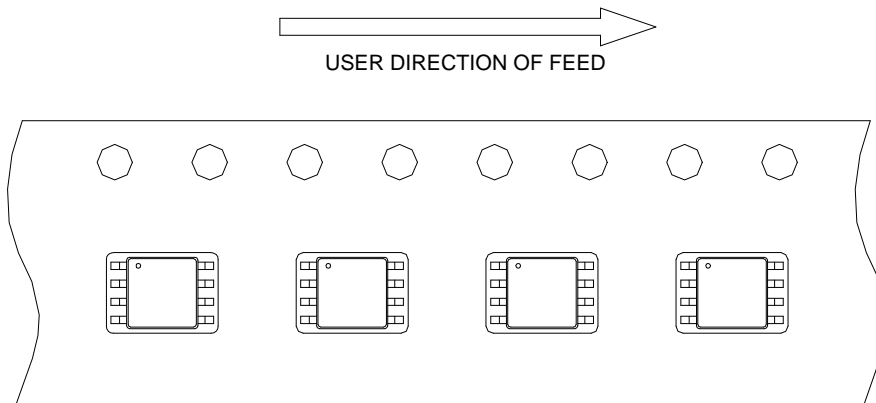
Package Type	Unit	Quantity
SOP-8	Tape & Reel	2500
MSOP-8	Tape & Reel	3000
TDFN2x2-8	Tape & Reel	3000
TSSOP-8	Tape & Reel	2500

**Taping Direction Information**

**SOP-8**

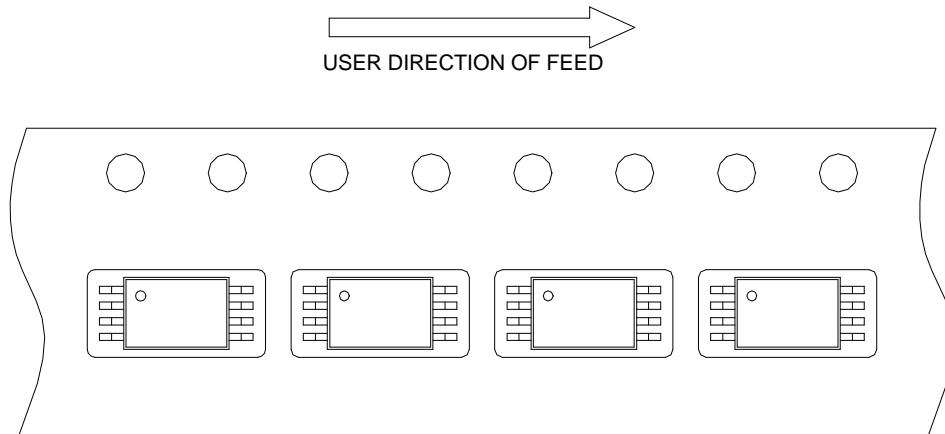


**MSOP-8**

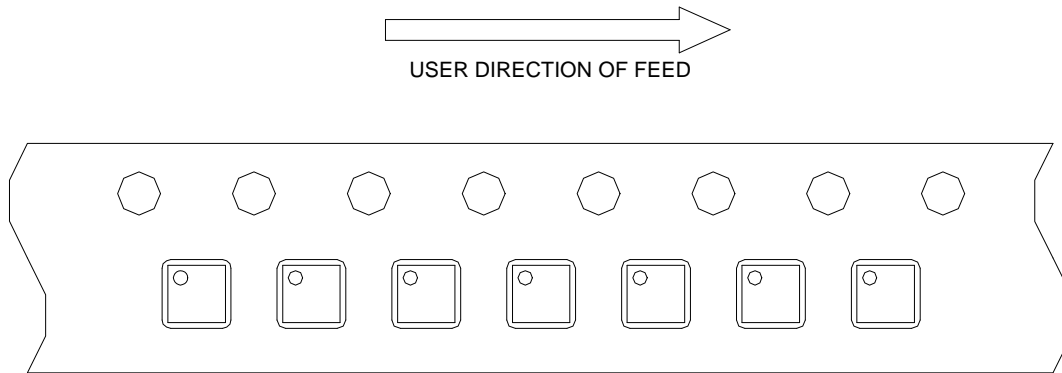


### Taping Direction Information

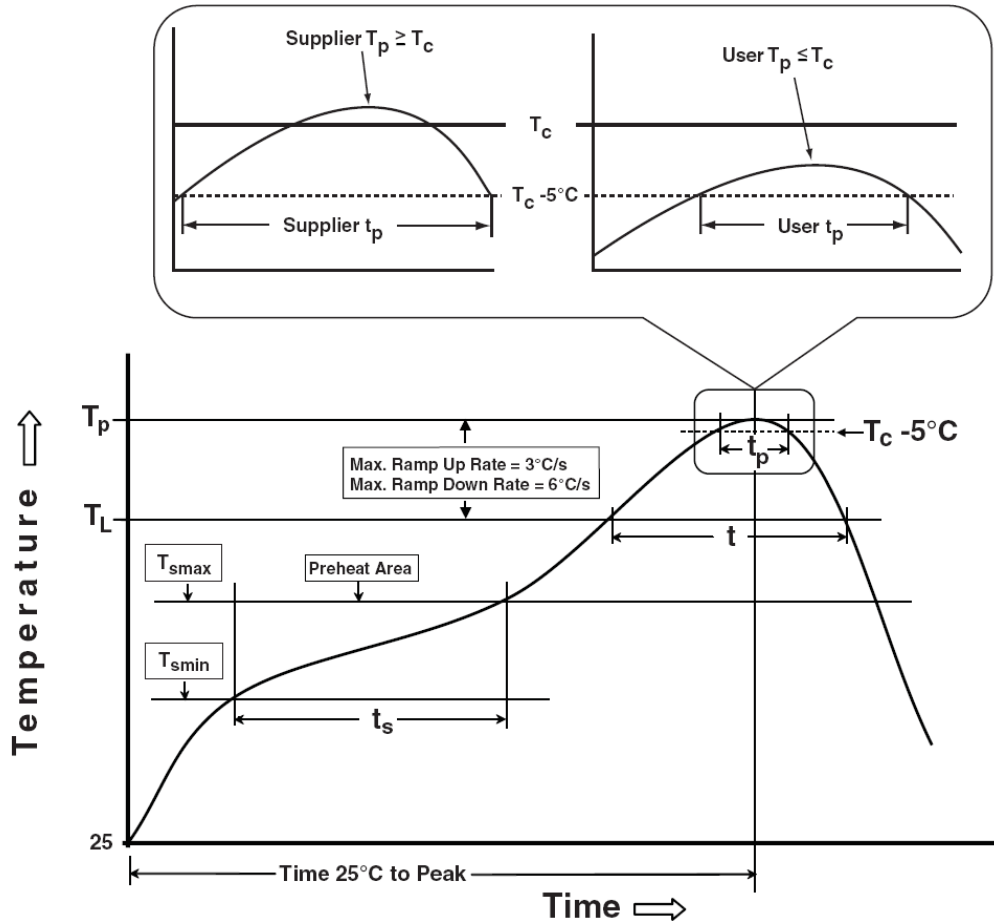
TSSOP-8



TDFN2x2-8



### Classification Profile



### Classification Reflow Profiles

Profile Feature	Sn-Pb Eutectic Assembly	Pb-Free Assembly
<b>Preheat &amp; Soak</b>		
Temperature min ( $T_{smin}$ )	100 °C	150 °C
Temperature max ( $T_{smax}$ )	150 °C	200 °C
Time ( $T_{smin}$ to $T_{smax}$ ) ( $t_s$ )	60-120 seconds	60-120 seconds
Average ramp-up rate ( $T_{smax}$ to $T_p$ )	3 °C/second max.	3 °C/second max.
Liquidous temperature ( $T_L$ )	183 °C	217 °C
Time at liquidous ( $t_L$ )	60-150 seconds	60-150 seconds
Peak package body Temperature ( $T_p$ )*	See Classification Temp in table 1	See Classification Temp in table 2
Time ( $t_p$ )** within 5°C of the specified classification temperature ( $T_c$ )	20** seconds	30** seconds
Average ramp-down rate ( $T_p$ to $T_{smax}$ )	6 °C/second max.	6 °C/second max.
Time 25°C to peak temperature	6 minutes max.	8 minutes max.
* Tolerance for peak profile Temperature ( $T_p$ ) is defined as a supplier minimum and a user maximum.		
** Tolerance for time at peak profile temperature ( $t_p$ ) is defined as a supplier minimum and a user maximum.		

## Classification Reflow Profiles (Cont.)

Table 1. SnPb Eutectic Process – Classification Temperatures (Tc)

Package Thickness	Volume mm <sup>3</sup> <350	Volume mm <sup>3</sup> ≥350
<2.5 mm	235 °C	220 °C
≥2.5 mm	220 °C	220 °C

Table 2. Pb-free Process – Classification Temperatures (Tc)

Package Thickness	Volume mm <sup>3</sup> <350	Volume mm <sup>3</sup> 350-2000	Volume mm <sup>3</sup> >2000
<1.6 mm	260 °C	260 °C	260 °C
1.6 mm – 2.5 mm	260 °C	250 °C	245 °C
≥2.5 mm	250 °C	245 °C	245 °C

## Reliability Test Program

Test item	Method	Description
SOLDERABILITY	JESD-22, B102	5 Sec, 245°C
HOLT	JESD-22, A108	1000 Hrs, Bias @ Tj=125°C
PCT	JESD-22, A102	168 Hrs, 100%RH, 2atm, 121°C
TCT	JESD-22, A104	500 Cycles, -65°C~150°C
HBM	MIL-STD-883-3015.7	VHBM 2KV
MM	JESD-22, A115	VMM 200V
Latch-Up	JESD 78	10ms, 1 <sub>tr</sub> 100mA

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